

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

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Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China











Flanged Termination 250 Watts, 50Ω



Features:

- DC 3.0 GHz
- 250 Watts
- BeO Ceramic
- Non-Nichrome Resistive Element
- Low VSWR
- 100% Tested

General Specifications

Resistive Element Thick film

Substrate Beryllium oxide ceramic

Cover Alumina Ceramic

Mounting Flange Copper, Nickel plated per QQ-N-290

Lead(s): 99.9% pure silver (.006 thick)

Electrical Specifications

Resistance Range:50 ohms, \pm 5%Frequency Range;DC - 3.0 GHzPower:250 Watts

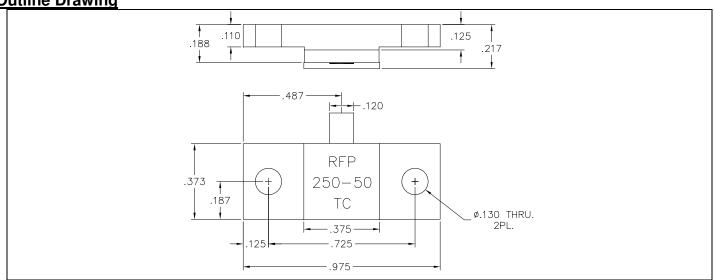
VSWR: 1.30:1 DC to 3.0 GHz

Note: Tolerance is ± 0.010 ", unless otherwise specified. Designed to meet of exceed applicable portions of MIL-E-5400. Operating temperature is -55 $^{\circ}$ C to 150 $^{\circ}$ C (see chart for derating temperatures).

All dimensions in inches.

Specifications subject to change with out notice.

Outline Drawing



250-50TC (097) Rev C



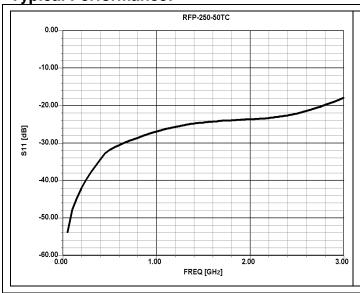


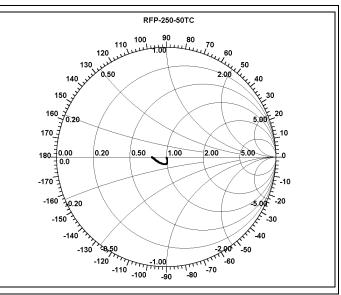
Available on Tape and Reel For Pick and Place Manufacturing. USA/Canada: (315) 432-8909 Toll Free: (800) 544-2414 Europe: +44 2392-232392





Typical Performance:





Power De-rating:

100 75 9 9 0 25 50 75 100 125 150 PCB TEMPERATURE - °C

Mounting Footprint and Procedure:



BOARD EVEN WITH LEAD.

SUGGESTED STRESS RELIEF METHODS

.025 MIN. (2 PLACES)

> BOARD LOWER THAN LEAD.

SUGGESTED MOUNTING PROCEDURES:

- MAKE SURE THAT THE DEVICES ARE MOUNTED ON FLAT SURFACES (.001" UNDER THE DEVICE) TO OPTIMIZE THE HEAT TRANSFER.
- 2. DRILL & TAP THE HEATSINK FOR THE APPROPRIATE THREAD SIZE TO BE USED.
- 3. COAT HEATSINK WITH A MINIMUM AMOUNT OF HIGH QUALITY SILICONE GREASE (.001" MAX. THICKNESS).
- 4. POSITION DEVICE ON MOUNTING SURFACE & SECURE USING SOCKET HEAD SCREWS, FLAT & SPLIT WASHER. TORQUE SCREWS TO THE APPROPRIATE VALUE. MAKE SURE THAT THE DEVICE IS FLAT AGAINST THE HEATSINK. (CARE SHOULD BE TAKEN TO AVOID UPWARD PRESSURE OF THE LEADS TOWARDS THE LID).

BOARD LOWER THAN LEAD.

NOT RECOMMENDED APPLICATION SCALE: NONE

BOARD HIGHER THAN LEAD.

5. SOLDER LEADS IN PLACE USING APPROPROATE SOLDER WITH A CONTROLLED TEMPERATURE IRON.

** FOR MORE DETAILS CONTACT FACTORY **

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